

Automatic High-Granularity Timing Detector Module

Assembly with Gantry System



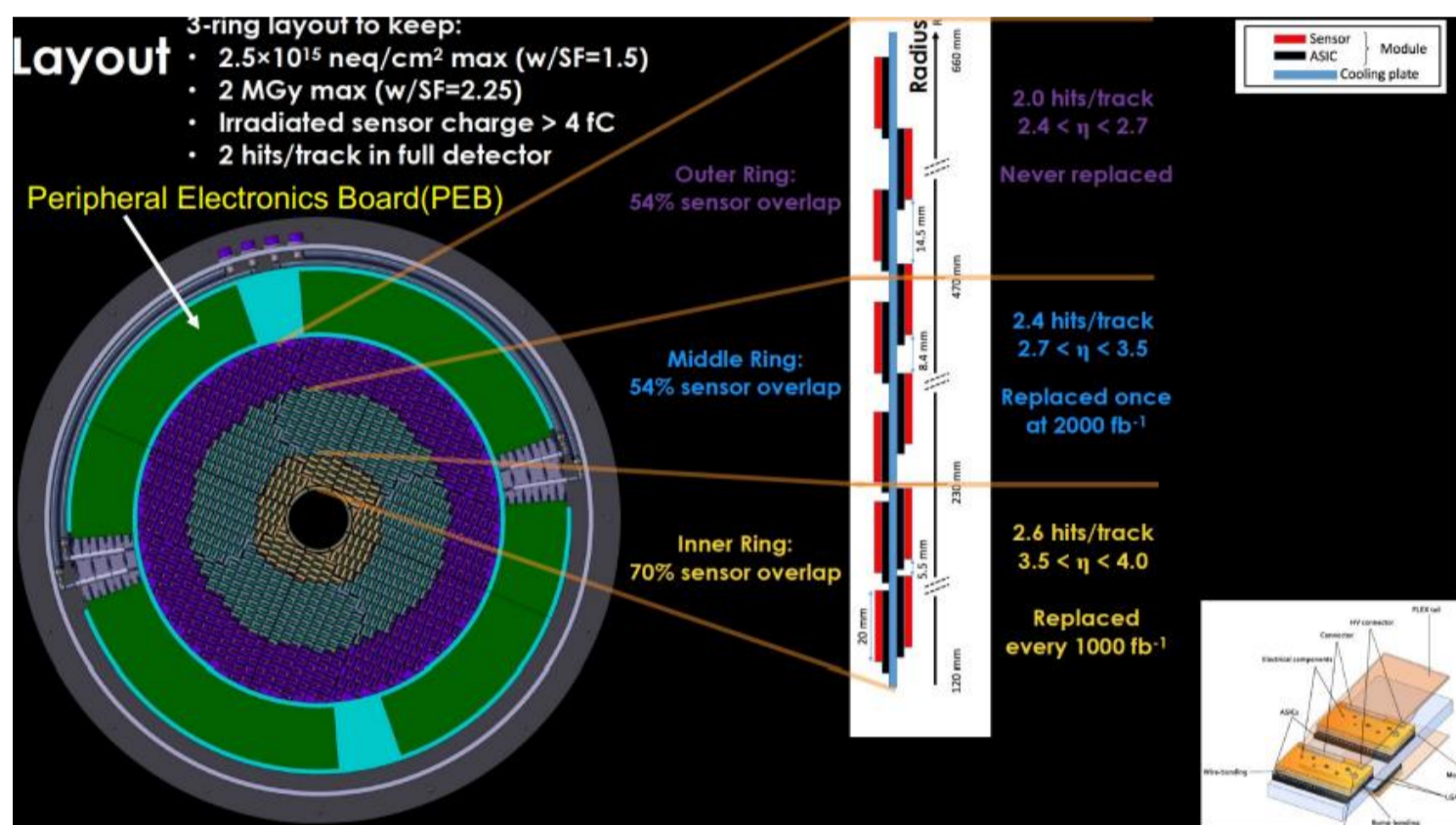
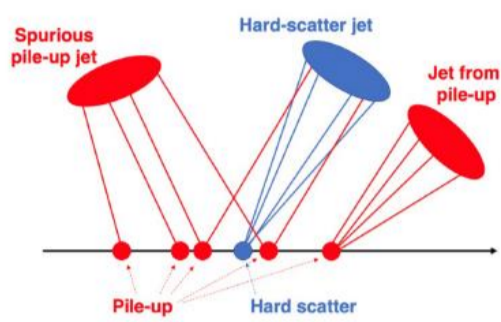
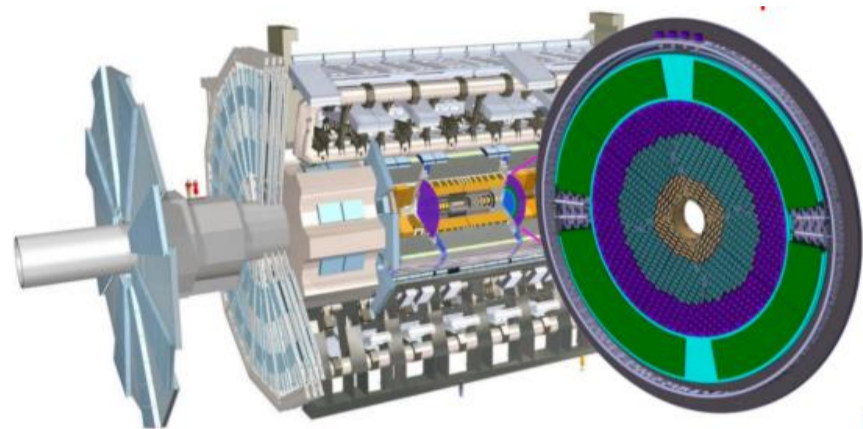
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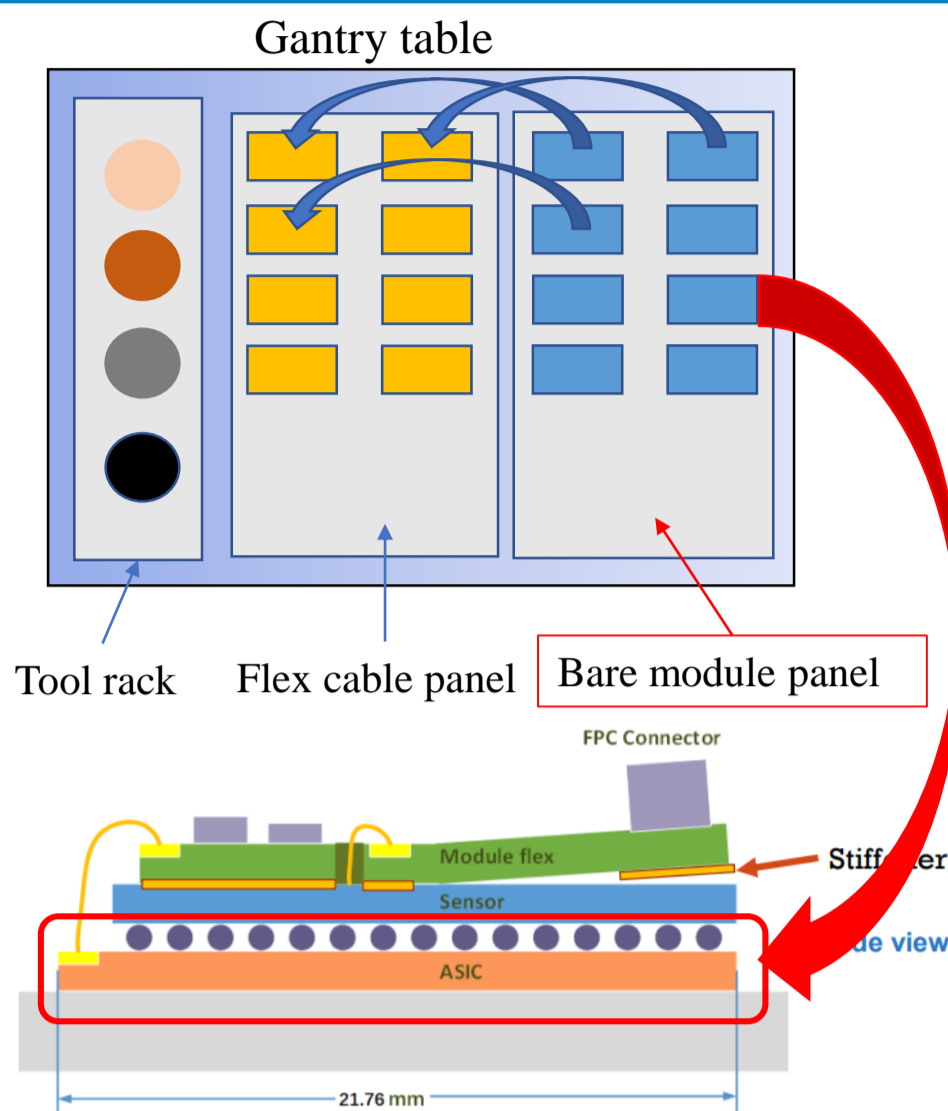
Introduction

High Granularity Timing Detector (HGTD)

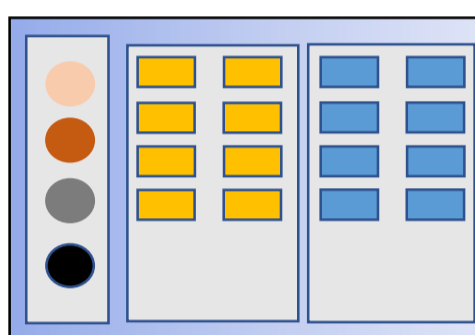
- HGTD aim to reduce pileup contribution at HL-LHC
 - Timing resolution is required to be better than 50ps
 - 6.4m² area silicon detector and ~ 3.6 × 10⁶ channels
 - High Granularity: Pixel pad size: 1.3mm × 1.3mm
 - Radiation hardness: 2.5 × 10¹⁵ N_{eq}/cm² and 2MGy



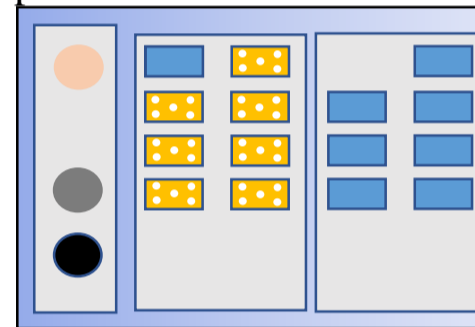
Example: Gluing of the bare module on the flex cable



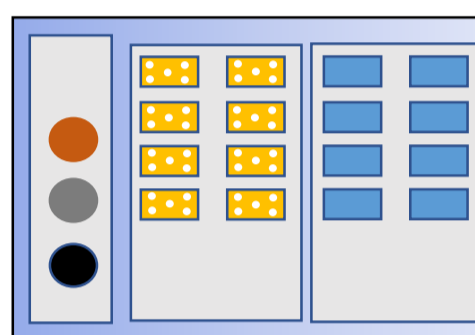
Prepare the tools, flex and bare module



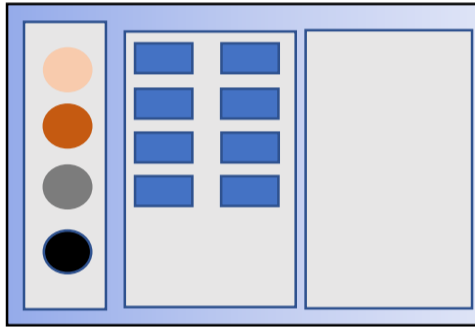
Pick the bare module and place it on the flex



Dispense glue on the flex

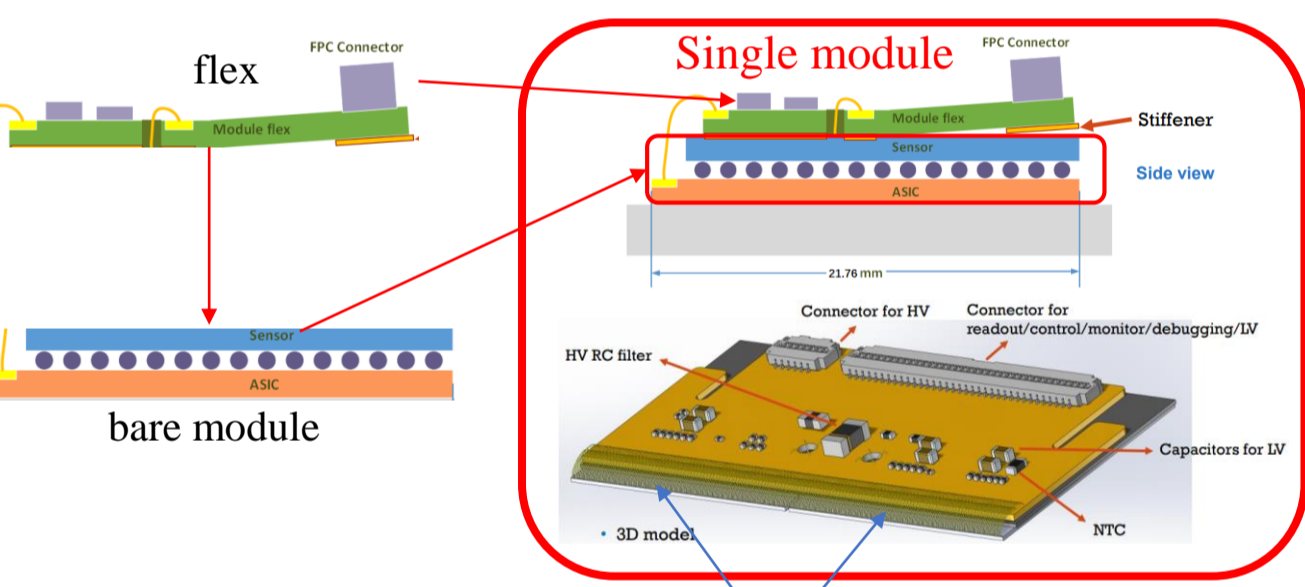


Finish picking and placing, put tools back on the rack

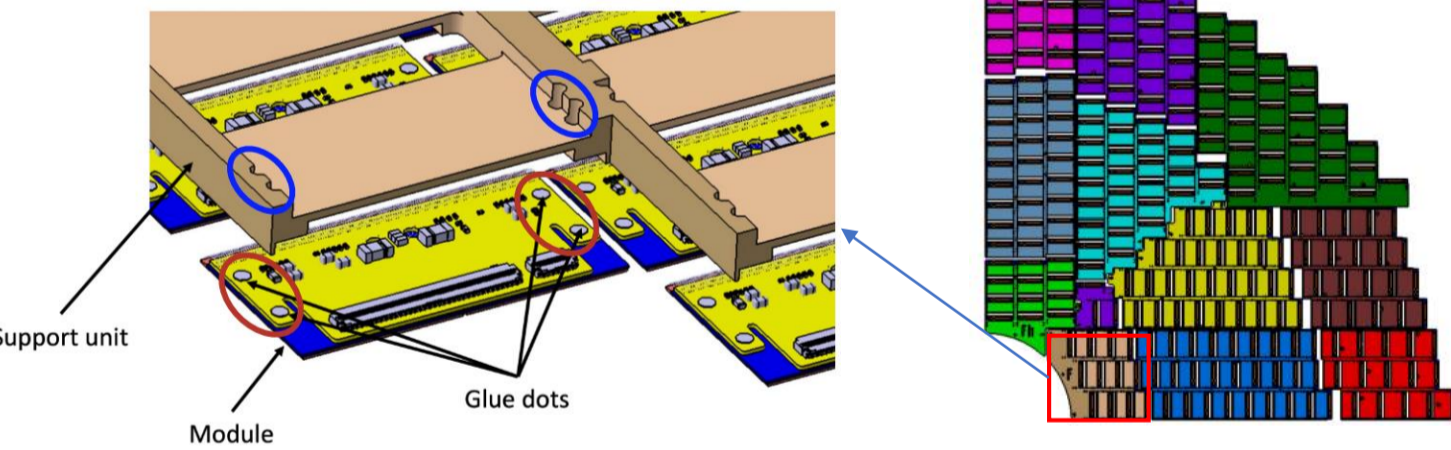


Task of the HGTD module assembly with gantry system

➤ Glue the flex on the two bare modules



➤ Glue the module on the support units



➤ Specification of the module mass and dimension

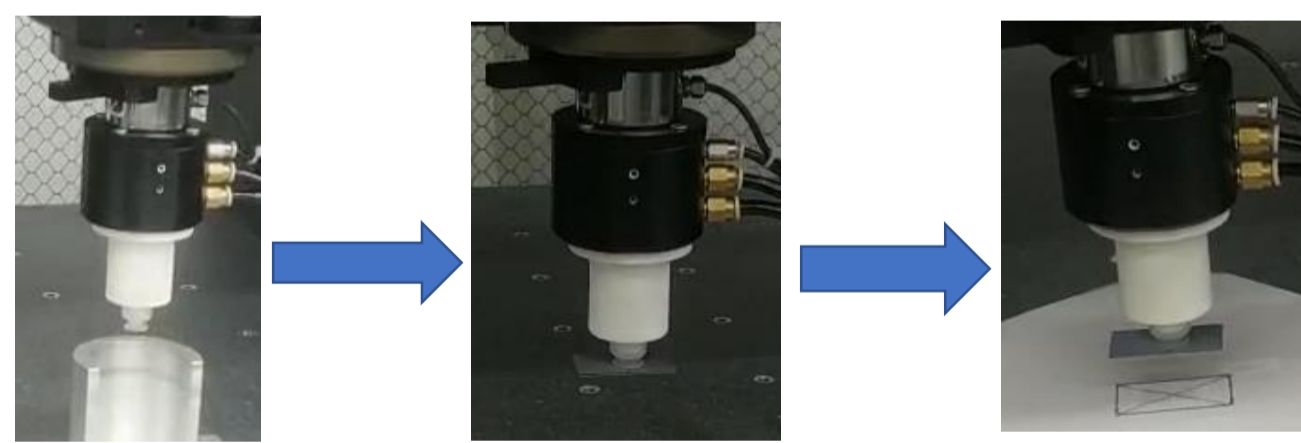
Module weight: 3.0 g	Nominal thickness of the module: 2.52 mm
Maximum thickness of the module: 3.32 mm	Maximum width of the module: 40.6 mm
Nominal gap between two bare modules: 200 μm	Minimum gap between two bare modules: 50 μm

Current status at IHEP

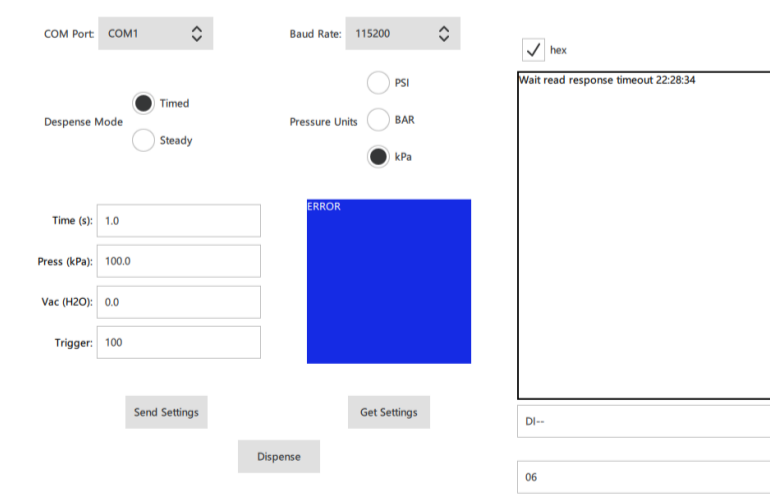
- Gantry system has already been installed with all hardware components in a clean room:
 - Vacuum system, air pressure system and vision system
- Positioning resolution validation was done with laser system (<1 μm)

Axis	Calibration interval	Test interval	Specification	Result
X	50mm	500mm	3 μm	1 μm
Y	50mm	500mm	3 μm	0.4 μm
Z	15mm	150mm	0.8 μm	0.8 μm
Theta	15°	360°	5arc sec	2.074arc sec

- Pick-and-place utilizing the vision system works very well
- Software developing is ongoing
 - Glue dispensing function is integrated



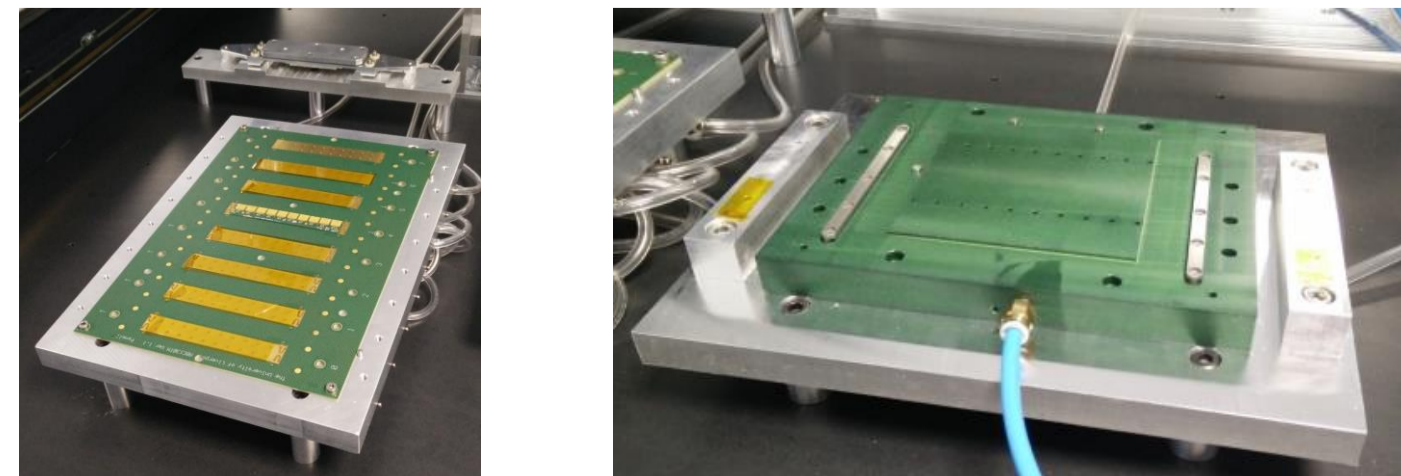
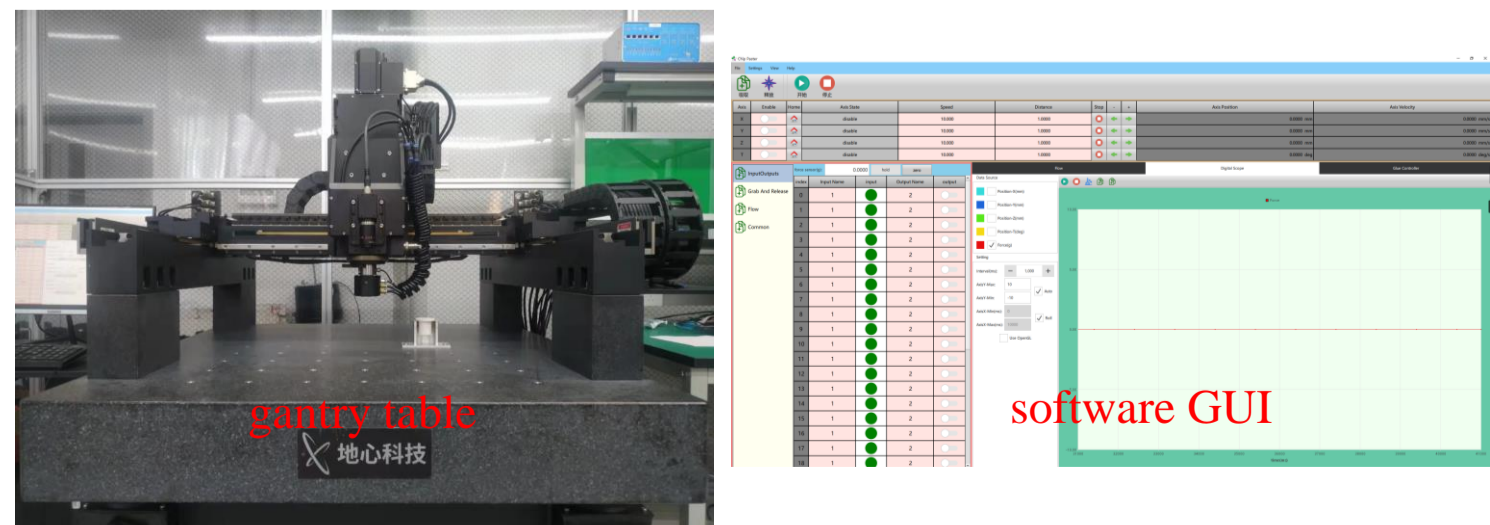
Picking tool Picking dummy sensor Placing dummy sensor



Dispenser controller integration

The gantry system at IHEP

- Robotic pick-and-place for systematic module assembly (gantry), consists of:
 - Coretech gantry positioning system with ACS motion controller (500 mm * 500 mm * 150 mm * 340° travel, repositioning resolution ~ 1 μm)
 - Integrated with Keyence vision system, pressure sensor, multi-channel electro-valves (maximum 32), Nordson EFD Glue Dispensing controller, flexible vacuum and air pressure piping system, and custom picking and gluing tools
 - Open source C++ Qt program with GUI to control the whole system (still developing)



Vacuum chucks for itk module assembly